

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	66246	(negative minus) with (capacitance capacitor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 19:08
L3	642971	(integrated with (circuit circuitry))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 19:00
L4	7683	(substrate carrier board ((silicon semiconductor wafer) with (substrate carrier layer))) and 2 and 3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 19:01
L5	6910	(terminal bond bondpad pad electrode) and 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 19:09
L6	2078	(dielectric polyimide polyimide polymer) and 5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 19:10
L7	1913	(active magnitude value) and 6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 19:22
L8	1433	(zero "0") and 7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 19:07
L9	152696	(negative minus) with (effect capacitance capacitor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 19:21

L10	1433	8 and 3 and 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 19:09
L11	7683	9 and 3 and 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 19:09
L12	6910	(terminal bond bondpad pad electrode) and 11	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 19:09
L13	7170	(terminal metal bond bondpad pad electrode) and 11	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 19:22
L14	2174	(dielectric polyimide polyimide polymer) and 13	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 19:22
L15	7760	(negative minus) with (effect and (capacitance capacitor))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 19:21
L16	1115	15 and 3 and 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 19:21
L17	1054	(terminal metal bond bondpad pad electrode) and 16	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 19:22

L18	361	(dielectric polyimide polyimide polymer) and 17	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 19:22
L19	338	(active magnitude value) and 18	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 19:22

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L1	17312	ZERO same (capacitor CAPACITANCE) same (bond pad terminal electrode BOND PAD) same (ACTIVE NEGATIVE)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 12:10
L2	729	ZERO with (capacitor CAPACITANCE) with (bond pad terminal electrode BOND PAD) with (ACTIVE NEGATIVE)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/20 12:10